





SN74LV4051A-Q1 SCLS520G – AUGUST 2003 – REVISED SEPTEMBER 2024

# SN74LV4051A-Q1 Automotive 8-Channel Analog Multiplexer or Demultiplexer

## **1** Features

Texas

INSTRUMENTS

- · Qualified for automotive applications
- AEC-Q100 qualified with the following results:
  - Device temperature grade 1: -40°C to +125°C ambient operating temperature range
  - Device HBM ESD classification level 2
  - Device CDM ESD classification level C4B
- 1.65V to 5.5V V<sub>CC</sub> operation
- Supports mixed-mode voltage operation
  on all ports
- · High on-off output-voltage ratio
- · Low crosstalk between switches
- · Individual switch controls
- · Extremely low input current
- Latch-up performance exceeds 100mA per JESD 78, class II

## 2 Applications

- · Automotive infotainment and cluster
- Telematics, eCall

## **3 Description**

This 8-channel CMOS analog multiplexer and demultiplexer is designed for 1.65V to 5.5V  $V_{CC}$  operation.

The SN74LV4051A-Q1 handles analog and digital signals. Each channel permits signals with amplitudes up to 5.5V (peak) to be transmitted in either direction.

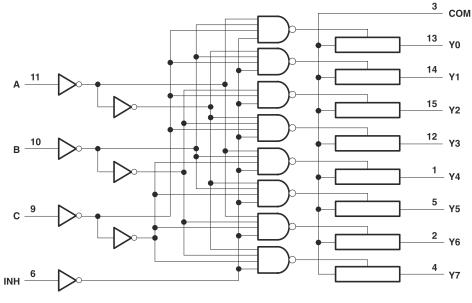
Applications include signal gating, chopping, modulation or demodulation (modem), and signal multiplexing for analog-to-digital and digital-to-analog conversion systems.

#### **Package Information**

| PART NUMBER    | PACKAGE <sup>(1)</sup>    | PACKAGE SIZE <sup>(2)</sup> |  |  |  |  |  |  |  |
|----------------|---------------------------|-----------------------------|--|--|--|--|--|--|--|
|                | PW (TSSOP, 16)            | 5mm × 6.4mm                 |  |  |  |  |  |  |  |
| SN74LV4051A-Q1 | D (SOIC, 16)              | 9.9mm × 6mm                 |  |  |  |  |  |  |  |
|                | DYY (SOT-23-<br>THIN, 16) | 4.2mm x 3.26mm              |  |  |  |  |  |  |  |

(1) For more information, see Section 11.

(2) The package size (length × width) is a nominal value and includes pins, where applicable.



Logic Diagram (Positive Logic)



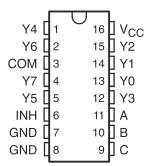
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## **4** Pin Configuration and Functions



#### Figure 4-1. D, PW or DYY Package, 16-Pin SOIC, TSSOP, or SOT-23-THIN (Top View)

| PIN    NAME  NO. |    |                  | DESCRIPTION                                                                                                 |  |  |
|------------------|----|------------------|-------------------------------------------------------------------------------------------------------------|--|--|
|                  |    |                  | DESCRIPTION                                                                                                 |  |  |
| Y4               | 1  | (2)              | Input to mux                                                                                                |  |  |
| Y6               | 2  | (2)              | Input to mux                                                                                                |  |  |
| СОМ              | 3  | O <sup>(2)</sup> | Output of mux                                                                                               |  |  |
| Y7               | 4  | (2)              | Input to mux                                                                                                |  |  |
| Y5               | 5  | <b>(</b> 2)      | Input to mux                                                                                                |  |  |
| INH              | 6  | l <sup>(2)</sup> | Enables the outputs of the device. Logic low level with turn the outputs on, high level will turn them off. |  |  |
| GND              | 7  |                  | Ground                                                                                                      |  |  |
| GND              | 8  | _                | Ground                                                                                                      |  |  |
| С                | 9  | I                | Selector line for outputs (see Section 7.4 for specific information)                                        |  |  |
| В                | 10 | I                | Selector line for outputs (see Section 7.4 for specific information)                                        |  |  |
| A                | 11 | I                | Selector line for outputs (see Section 7.4 for specific information)                                        |  |  |
| Y3               | 12 | (2)              | Input to mux                                                                                                |  |  |
| Y0               | 13 | <b>(</b> 2)      | Input to mux                                                                                                |  |  |
| Y1               | 14 | <b>(</b> 2)      | Input to mux                                                                                                |  |  |
| Y2               | 15 | (2)              | Input to mux                                                                                                |  |  |
| Vcc              | 16 | I                | Device power input                                                                                          |  |  |

#### Table 4-1. Pin Functions

(1) I = input, O = output

(2) These I/O descriptions represent the device when used as a multiplexer, when this device is operated as a demultiplexer pins Y0-Y7 may be considered outputs (O) and the COM pin may be considered inputs (I).

## **5** Specifications

## 5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1) (3)</sup>

|                  |                                                   |                                     | MIN  | MAX                   | UNIT |
|------------------|---------------------------------------------------|-------------------------------------|------|-----------------------|------|
| V <sub>CC</sub>  | Supply voltage                                    |                                     | -0.5 | 7.0                   | V    |
| VI               | Logic input voltage range                         | Logic input voltage range           |      | 7.0                   | V    |
| V <sub>IO</sub>  | Switch I/O voltage range <sup>(2) (3)</sup>       |                                     | -0.5 | V <sub>CC</sub> + 0.5 | V    |
| I <sub>IK</sub>  | Input clamp current                               | V <sub>1</sub> < 0                  | -20  |                       | mA   |
| I <sub>IOK</sub> | Switch IO diode clamp current                     | $V_{IO}$ < 0 or $V_{IO}$ > $V_{CC}$ | -50  |                       | mA   |
| IT               | Switch continuous current                         | $V_{IO}$ = 0 to $V_{CC}$            |      | ±25                   | mA   |
|                  | Continuous current through V <sub>CC</sub> or GND |                                     |      | ±50                   | mA   |
| T <sub>stg</sub> | Storage temperature                               |                                     | -65  | 150                   | °C   |

(1) Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute maximum ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If briefly operating outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not sustain damage, but it may not be fully functional. Operating the device in this manner may affect device reliability, functionality, performance, and shorten the device lifetime.

(2) Pins are diode-clamped to the power-supply rails. Over voltage signals must be voltage and current limited to maximum ratings.

(3) This value is limited to 5.5 V maximum

## 5.2 ESD Ratings

|                    |                         |                                                         |          | VALUE | UNIT |
|--------------------|-------------------------|---------------------------------------------------------|----------|-------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human body model (HBM), per AEC Q100-002 <sup>(1)</sup> | All pins | ±2000 | V    |
| V <sub>(ESD)</sub> | Electrostatic discharge | Charged device model (CDM), per AEC Q100-011            | All pins | ±500  | V    |

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.



## 5.3 Thermal Information: SN74LV4051A-Q1

|                       |                                              | SN74LV4051A-Q1 | SN74LV4051A-Q1 |      |
|-----------------------|----------------------------------------------|----------------|----------------|------|
|                       | THERMAL METRIC <sup>(1)</sup>                | PW (TSSOP)     | DYY (SOT)      | UNIT |
|                       |                                              | 16 PINS        | 16 PINS        |      |
| R <sub>θJA</sub>      | Junction-to-ambient thermal resistance       | 140.2          | 199.7          | °C/W |
| R <sub>0JC(top)</sub> | Junction-to-case (top) thermal resistance    | 72.6           | 121.2          | °C/W |
| R <sub>θJB</sub>      | Junction-to-board thermal resistance         | 98.7           | 129.0          | °C/W |
| $\Psi_{JT}$           | Junction-to-top characterization parameter   | 13.4           | 24.6           | °C/W |
| Ψ <sub>JB</sub>       | Junction-to-board characterization parameter | 97.3           | 126.7          | °C/W |
| R <sub>θJC(bot)</sub> | Junction-to-case (bottom) thermal resistance | N/A            | N/A            | °C/W |

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

## **5.4 Recommended Operating Conditions**

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                 |                                                   |                                   | MIN                   | NOM MAX               | UNIT      |
|-----------------|---------------------------------------------------|-----------------------------------|-----------------------|-----------------------|-----------|
| V <sub>CC</sub> | Supply voltage                                    |                                   | 1 <sup>(2)</sup>      | 5.5                   | V         |
|                 |                                                   | V <sub>CC</sub> = 1.65            | 1.2                   | 5.5                   |           |
|                 |                                                   | V <sub>CC</sub> = 2 V             | 1.5                   | 5.5                   |           |
| V <sub>IH</sub> | High-level input voltage,<br>logic control inputs | V <sub>CC</sub> = 2.3 V to 2.7 V  | V <sub>CC</sub> x 0.7 | 5.5                   | V         |
|                 |                                                   | V <sub>CC</sub> = 3 V to 3.6 V    | V <sub>CC</sub> x 0.7 | 5.5                   |           |
|                 |                                                   | V <sub>CC</sub> = 4.5 V to 5.5 V  | V <sub>CC</sub> x 0.7 | 5.5                   |           |
|                 |                                                   | V <sub>CC</sub> = 1.65 V to 2.7 V | 0                     | 0.4                   |           |
|                 | Low-level input voltage,<br>logic control inputs  | V <sub>CC</sub> = 1.65 V to 2.7 V | 0                     | 0.5                   |           |
| V <sub>IL</sub> |                                                   | V <sub>CC</sub> = 1.65 V to 2.7 V | 0                     | V <sub>CC</sub> x 0.3 | V         |
|                 |                                                   | V <sub>CC</sub> = 3 V to 3.6 V    | 0                     | V <sub>CC</sub> x 0.3 |           |
|                 |                                                   | V <sub>CC</sub> = 4.5 V to 5.5 V  | 0                     | V <sub>CC</sub> x 0.3 |           |
| VI              | Logic control input voltage                       |                                   | 0                     | 5.5                   | V         |
| V <sub>IO</sub> | Switch input or output voltage                    |                                   | 0                     | V <sub>CC</sub>       | V         |
|                 |                                                   | V <sub>CC</sub> = 1.0 V to 2.0 V  |                       | 500                   |           |
| A + / A \ /     | Lenis in mut the neitien vise on fell note        | V <sub>CC</sub> = 2.0 V to 2.7 V  |                       | 200                   | ··· • / / |
| Δt/ΔV           | Logic input transition rise or fall rate          | V <sub>CC</sub> = 3 V to 3.6 V    |                       | 100                   | ns/V      |
|                 |                                                   | $V_{CC}$ = 4.5 V to 5.5 V         |                       | 20                    |           |
| T <sub>A</sub>  | Ambient temperature                               | I                                 | -40                   | 125                   | °C        |

All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to TI application report *Implications of Slow or Floating CMOS Inputs*, SCBA004. When using a  $V_{CC}$  of  $\leq 1.2$  V, it is recommended to use these devices only for transmitting digital signals. (1)

(2) When supply voltage is near 1.2 V the analog switch ON resistance becomes very non-linear

#### **5.5 Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

|                 | PARAMETER       | Condition                                                          | T <sub>A</sub> | V <sub>cc</sub> | MIN | TYP | MAX | UNIT |
|-----------------|-----------------|--------------------------------------------------------------------|----------------|-----------------|-----|-----|-----|------|
|                 |                 |                                                                    | 25°C           |                 |     | 60  | 150 |      |
|                 |                 |                                                                    | –40°C to 85°C  | 1.65 V          |     |     | 225 |      |
|                 |                 |                                                                    | –40°C to 125°C |                 |     |     | 225 |      |
|                 |                 |                                                                    | 25°C           |                 |     | 38  | 180 |      |
|                 |                 |                                                                    | –40°C to 85°C  | 2.3 V           |     |     | 225 |      |
| -               | ON-state switch | ate switch $I_T = 2 \text{ mA},$<br>$V_I = V_{CC} \text{ or GND},$ | –40°C to 125°C |                 |     |     | 225 | Ω    |
| r <sub>ON</sub> | resistance      | $V_{I} = V_{CC} O GND,$<br>$V_{INH} = V_{IL}$                      | 25°C           |                 |     | 30  | 150 | 12   |
|                 |                 |                                                                    | –40°C to 85°C  | 3 V             |     |     | 190 |      |
|                 |                 |                                                                    | –40°C to 125°C |                 |     |     | 190 |      |
|                 |                 |                                                                    | 25°C           |                 | 22  | 75  |     |      |
|                 |                 |                                                                    | –40°C to 85°C  | 4.5 V           |     |     | 100 |      |
|                 |                 |                                                                    | –40°C to 125°C |                 |     |     | 100 |      |



## 5.5 Electrical Characteristics (continued)

over recommended operating free-air temperature range (unless otherwise noted)

|                  | PARAMETER                            | Condition                                                          | T <sub>A</sub> | V <sub>cc</sub> | MIN    | TYP  | MAX | UNIT |
|------------------|--------------------------------------|--------------------------------------------------------------------|----------------|-----------------|--------|------|-----|------|
|                  |                                      |                                                                    | 25°C           |                 |        | 220  | 600 |      |
|                  |                                      |                                                                    | –40°C to 85°C  | 1.65 V          |        |      | 700 |      |
|                  |                                      |                                                                    | -40°C to 125°C |                 |        |      | 700 |      |
|                  |                                      |                                                                    | 25°C           |                 |        | 113  | 500 |      |
|                  |                                      |                                                                    | –40°C to 85°C  | 2.3 V           |        |      | 600 |      |
|                  | Peak ON-state                        | $I_T = 2 \text{ mA},$<br>V <sub>I</sub> = GND to V <sub>CC</sub> , | –40°C to 125°C |                 |        |      | 600 | Ω    |
| ON(p)            | resistance                           | $V_{I} = GND to V_{CC},$<br>$V_{INH} = V_{IL}$                     | 25°C           |                 |        | 54   | 180 | Ω    |
|                  |                                      |                                                                    | -40°C to 85°C  | 3 V             |        |      | 225 |      |
|                  |                                      |                                                                    | -40°C to 125°C |                 |        |      | 225 |      |
|                  |                                      |                                                                    | 25°C           |                 |        | 31   | 100 |      |
|                  |                                      |                                                                    | –40°C to 85°C  | 4.5 V           | 5 V 12 | 125  |     |      |
|                  |                                      |                                                                    | -40°C to 125°C |                 |        |      | 125 |      |
|                  |                                      |                                                                    | 25°C           |                 |        |      |     |      |
|                  |                                      |                                                                    | –40°C to 85°C  | 1.65 V          |        |      |     |      |
|                  |                                      | -40°C to 85°C                                                      |                |                 |        |      |     |      |
|                  |                                      |                                                                    | -40°C to 85°C  |                 |        | 2.1  | 30  |      |
|                  |                                      |                                                                    | –40°C to 85°C  | 2.3 V           |        |      | 40  |      |
| Δ                | Difference in ON-                    | $I_T = 2 \text{ mA},$                                              | -40°C to 125°C | —               |        |      | 40  | Ω    |
| ∆r <sub>ON</sub> | state resistance<br>between switches | $V_{I} = GND$ to $V_{CC}$ ,<br>$V_{INH} = V_{IL}$                  | 25°C           |                 |        | 1.4  | 20  |      |
|                  |                                      |                                                                    | –40°C to 85°C  | 3 V             |        |      | 30  |      |
|                  |                                      |                                                                    | -40°C to 125°C |                 |        |      | 30  |      |
|                  |                                      |                                                                    | 25°C           |                 |        | 1.3  | 15  |      |
|                  |                                      |                                                                    | –40°C to 85°C  | 4.5 V           |        |      | 20  |      |
|                  |                                      |                                                                    | -40°C to 125°C |                 |        |      | 20  |      |
|                  |                                      |                                                                    | 25°C           |                 | -0.1   |      | 0.1 |      |
| н                | Control input current                | $V_{I} = 5.5 V \text{ or GND}$                                     | –40°C to 85°C  | 0 to 5.5 V      | -1     |      | 1   | μA   |
| IL               |                                      |                                                                    | –40°C to 125°C |                 | -2     |      | 2   | •    |
|                  |                                      | $V_{I} = V_{CC}$ and $V_{O} =$                                     | 25°C           |                 | -0.1   |      | 0.1 |      |
|                  | OFF-state switch                     | GND,<br>or $V_1$ = GND and $V_0$ =                                 | -40°C to 85°C  | 5.5 V           | -1     |      | 1   |      |
| S(off)           | leakage current                      | $V_{CC}$ ,<br>$V_{INH} = V_{IH}$                                   | -40°C to 125°C | 5.5 V           | -2     |      | 2   | μA   |
|                  |                                      |                                                                    | 25°C           |                 | -0.1   |      | 0.1 |      |
| S(on)            | ON-state switch                      | $V_{I} = V_{CC}$ or GND,                                           | -40°C to 85°C  | 5.5 V           | -1     |      | 1   | μA   |
| 0(01)            | leakage current                      | $V_{INH} = V_{IL}$                                                 | -40°C to 125°C |                 | -2     |      | 2   |      |
|                  |                                      |                                                                    | 25°C           |                 |        |      |     |      |
| сс               | Supply current                       | $V_{I} = V_{CC}$ or GND                                            | -40°C to 85°C  | 5.5 V           |        |      | 20  | μA   |
|                  |                                      | V <sub>INH</sub> = 0 V                                             | -40°C to 125°C |                 |        |      | 40  |      |
| CIC              | Control input capacitance            | f = 10 MHz                                                         | 25°C           | 3.3 V           |        | 2    |     | pF   |
| C <sub>IS</sub>  | Common terminal capacitance          | f = 10 MHz                                                         | 25°C           | 3.3 V           |        | 23.4 |     | pF   |
| C <sub>OS</sub>  | Switch ternminal capacitance         | f = 10 MHz                                                         | 25°C           | 3.3 V           |        | 5.7  |     | pF   |
| C <sub>F</sub>   | Feedthrough capacitance              | f = 10 MHz                                                         | 25°C           | 3.3 V           |        | 0.5  |     | pF   |

### 5.5 Electrical Characteristics (continued)

over recommended operating free-air temperature range (unless otherwise noted)

| F               | PARAMETER                        | Condition                             | T <sub>A</sub> | V <sub>cc</sub> | MIN | TYP | MAX | UNIT |
|-----------------|----------------------------------|---------------------------------------|----------------|-----------------|-----|-----|-----|------|
| C <sub>PD</sub> | Power dissipation<br>capacitance | C <sub>L</sub> = 50 pF, f = 10<br>MHz | 25°C           | 3.3 V           |     | 5.9 |     | pF   |

## 5.6 Timing Characteristics V<sub>CC</sub> = 2.5 V $\pm$ 0.2 V

| I                                                      | PARAMETER                 | FROM (INPUT)          | TO (OUTPUT)                | CONDITIONS                | T <sub>A</sub> | MIN            | TYP  | MAX | UNIT |
|--------------------------------------------------------|---------------------------|-----------------------|----------------------------|---------------------------|----------------|----------------|------|-----|------|
|                                                        | <b>-</b> "                |                       |                            |                           | 25°C           |                | 1.9  | 10  |      |
| t <sub>PLH</sub><br>t <sub>PHL</sub>                   | Propagation<br>delay time | COM or Yn             | Yn or COM                  | C <sub>L</sub> = 15 pF    | –40°C to 85°C  |                |      | 16  | ns   |
|                                                        |                           |                       |                            |                           | –40°C to 125°C |                |      | 18  |      |
|                                                        |                           |                       |                            |                           | 25°C           |                | 6.6  | 18  |      |
| t <sub>PZH</sub> Enable delay<br>t <sub>PZL</sub> time | INH                       | COM or Yn             | C <sub>L</sub> = 15 pF     | –40°C to 85°C             |                |                | 23   | ns  |      |
|                                                        |                           |                       |                            |                           | –40°C to 125°C |                |      | 25  |      |
|                                                        |                           | Disable delay<br>time |                            |                           | 25°C           |                | 7.4  | 18  |      |
| t <sub>PHZ</sub> Disable dela<br>t <sub>PLZ</sub> time |                           |                       | COM or Yn                  | Yn C <sub>L</sub> = 15 pF | –40°C to 85°C  |                |      | 23  | ns   |
|                                                        |                           |                       |                            |                           | –40°C to 125°C |                |      | 25  |      |
|                                                        |                           |                       |                            |                           | 25°C           |                | 3.8  | 12  |      |
| t <sub>PLH</sub><br>t <sub>PHL</sub>                   | Propagation<br>delay time | COM or Yn             | Yn or COM                  | C <sub>L</sub> = 50 pF    | –40°C to 85°C  |                |      | 18  | ns   |
| PHL                                                    |                           |                       |                            |                           |                | –40°C to 125°C |      |     | 20   |
|                                                        |                           |                       |                            |                           | 25°C           |                | 7.8  | 28  |      |
| t <sub>PZH</sub><br>t <sub>PZL</sub>                   | Enable delay<br>time      | INH                   | COM or Yn                  | C <sub>L</sub> = 50 pF    | –40°C to 85°C  |                |      | 35  | ns   |
| PZL                                                    |                           |                       |                            |                           | –40°C to 125°C |                |      | 35  |      |
|                                                        |                           |                       |                            |                           | 25°C           | 1              | 11.5 | 28  |      |
| t <sub>PHZ</sub><br>t <sub>PLZ</sub>                   | Disable delay<br>time     | Disable delay INH     | COM or Yn C <sub>L</sub> = | C <sub>L</sub> = 50 pF    | –40°C to 85°C  |                |      | 35  | ns   |
| PLZ                                                    |                           |                       |                            |                           | –40°C to 125°C |                |      | 35  |      |

## 5.7 Timing Characteristics V\_{CC} = 3.3 V $\pm$ 0.3 V

| P/                                   | ARAMETER                  | FROM (INPUT) | TO (OUTPUT) | CONDITIONS             | T <sub>A</sub> | MIN | TYP | MAX | UNIT |  |
|--------------------------------------|---------------------------|--------------|-------------|------------------------|----------------|-----|-----|-----|------|--|
|                                      | -                         |              |             |                        | 25°C           |     | 2.5 | 9   |      |  |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation<br>delay time | COM or Yn    | Yn or COM   | C <sub>L</sub> = 50 pF | –40°C to 85°C  |     |     | 12  | ns   |  |
|                                      |                           |              |             |                        | –40°C to 125°C |     |     | 14  |      |  |
|                                      |                           |              |             |                        | 25°C           |     | 5.5 | 20  |      |  |
| t <sub>PZH</sub><br>t <sub>PZL</sub> | Enable delay<br>time      | INH          | COM or Yn   | C <sub>L</sub> = 50 pF | –40°C to 85°C  |     |     | 25  | ns   |  |
| PZL                                  |                           |              |             |                        | –40°C to 125°C |     |     | 25  |      |  |
|                                      |                           |              |             |                        | 25°C           |     | 8.8 | 20  |      |  |
| t <sub>PHZ</sub><br>t <sub>PLZ</sub> | Disable delay<br>time     | INH          | COM or Yn   | C <sub>L</sub> = 50 pF | –40°C to 85°C  |     |     | 25  | ns   |  |
|                                      |                           |              |             |                        | –40°C to 125°C |     |     | 25  |      |  |

## 5.8 Timing Characteristics V<sub>CC</sub> = 5 V ± 0.5 V

| P.                                   | ARAMETER                  | ER FROM (INPUT) TO (OUTPUT) CONDITIONS |           | T <sub>A</sub>         | MIN            | TYP | MAX | UNIT  |    |
|--------------------------------------|---------------------------|----------------------------------------|-----------|------------------------|----------------|-----|-----|-------|----|
| t <sub>PLH</sub><br>t <sub>PHL</sub> |                           |                                        |           |                        | 25°C           |     | 1.5 | 1.5 6 |    |
|                                      | Propagation<br>delav time | COM or Yn                              | Yn or COM | C <sub>L</sub> = 50 pF | –40°C to 85°C  |     |     | 8     | ns |
|                                      |                           |                                        |           |                        | –40°C to 125°C |     |     | 10    |    |



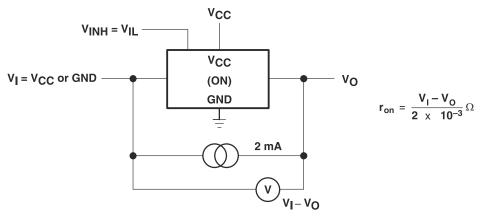
## 5.8 Timing Characteristics $V_{CC}$ = 5 V ± 0.5 V (continued)

| PA                                   | ARAMETER              | FROM (INPUT) | TO (OUTPUT) | CONDITIONS             | T <sub>A</sub> | MIN | TYP | MAX | UNIT |
|--------------------------------------|-----------------------|--------------|-------------|------------------------|----------------|-----|-----|-----|------|
|                                      |                       |              |             |                        | 25°C           |     | 4   | 14  |      |
| t <sub>PZH</sub><br>t <sub>PZL</sub> | Enable delay<br>time  | INH          | COM or Yn   | C <sub>L</sub> = 50 pF | –40°C to 85°C  |     |     | 18  | ns   |
| PZL                                  |                       |              |             |                        | –40°C to 125°C |     |     | 18  |      |
|                                      |                       |              |             |                        | 25°C           |     | 6.2 | 14  |      |
| t <sub>PHZ</sub><br>t <sub>PLZ</sub> | Disable delay<br>time | INH          | COM or Yn   | C <sub>L</sub> = 50 pF | –40°C to 85°C  |     |     | 18  | ns   |
|                                      |                       |              |             |                        | –40°C to 125°C |     |     | 18  |      |

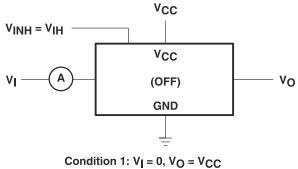
## **5.9 AC Characteristics**

| PARAMETER               | FROM (INPUT)                                                               | TO (OUTPUT) | Device                  | CONDIT                                                                                     | IONS                                    | MIN TYP | MAX | UNIT |  |
|-------------------------|----------------------------------------------------------------------------|-------------|-------------------------|--------------------------------------------------------------------------------------------|-----------------------------------------|---------|-----|------|--|
| Frequency               |                                                                            |             |                         | C <sub>L</sub> = 50 pF, R <sub>L</sub> =                                                   | V <sub>CC</sub> = 2.3 V                 | 20      |     |      |  |
| response (switch        | COM or Yn                                                                  | Yn or COM   | SN74LV4051              | 600 Ω,<br>F <sub>in</sub> = 1 MHz (sine                                                    | V <sub>CC</sub> = 3 V                   | 25      |     | MHz  |  |
| on)                     |                                                                            | wave)       | V <sub>CC</sub> = 4.5 V | 35                                                                                         |                                         |         |     |      |  |
| Feedthrough             |                                                                            |             |                         | C <sub>L</sub> = 50 pF, R <sub>L</sub> =                                                   | V <sub>CC</sub> = 2.3 V                 | -45     |     |      |  |
| attenuation             | COM or Yn                                                                  | Yn or COM   | ALL                     | 600 Ω,<br>F <sub>in</sub> = 1 MHz (sine                                                    | V <sub>CC</sub> = 3 V                   | -45     |     | dB   |  |
| (switch off)            |                                                                            |             |                         |                                                                                            | V <sub>CC</sub> = 4.5 V                 | -45     |     |      |  |
| Crosstalk               |                                                                            |             |                         | $C_L = 50 \text{ pF}, \text{ R}_L = 600 \Omega,$<br>$F_{in} = 1 \text{ MHz} \text{ (sine}$ |                                         | 20      |     | mV   |  |
| (between any            | COM or Yn                                                                  | Yn or COM   | ALL                     |                                                                                            | V <sub>CC</sub> = 3 V                   | 35      |     |      |  |
| switches)               |                                                                            |             |                         | wave)                                                                                      | V <sub>CC</sub> = 4.5 V                 | 60      |     |      |  |
|                         | $C_{L} = 50 \text{ pF, } R_{L} = \frac{V_{I} = 2 V_{p-p}}{V_{CC} = 2.3 V}$ |             | 0.1                     |                                                                                            |                                         |         |     |      |  |
| Sine-wave<br>distortion | COM or Yn                                                                  | Yn or COM   | ALL                     | 10 kΩ,<br>F <sub>in</sub> = 1 kHz (sine                                                    | $V_{I} = 2.5 V_{p-p}$                   | 0.1     |     | %    |  |
|                         |                                                                            |             |                         | wave)                                                                                      | $V_{I} = 4 V_{p-p}$<br>$V_{CC} = 4.5 V$ | 0.1     |     |      |  |

## **6** Parameter Measurement Information







Condition 1:  $V_I = 0$ ,  $V_O = V_{CC}$ Condition 2:  $V_I = V_{CC}$ ,  $V_O = 0$ 



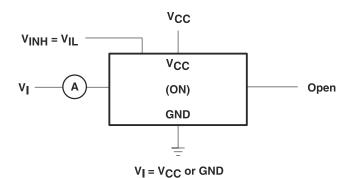
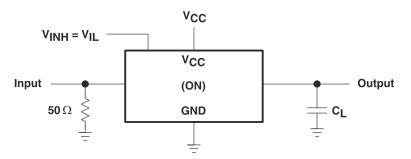


Figure 6-3. On-State Switch Leakage-Current Test Circuit





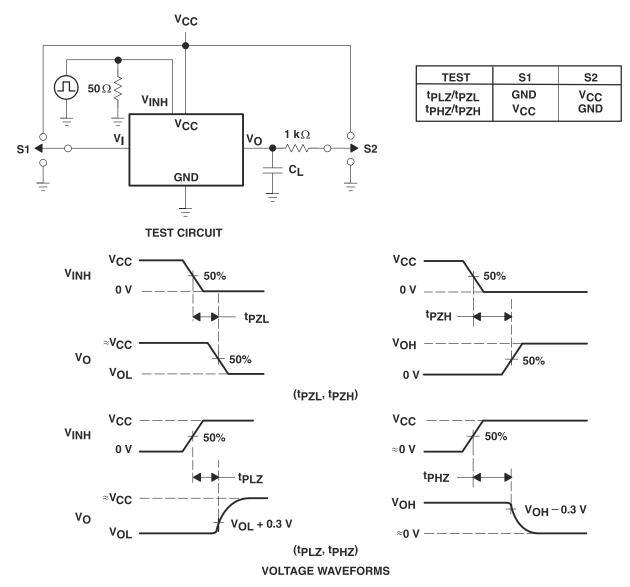
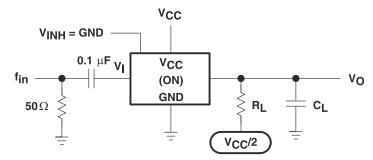


Figure 6-5. Switching Time (t<sub>PZL</sub>, t<sub>PLZ</sub>, t<sub>PLZ</sub>, t<sub>PHZ</sub>), Control to Signal Output





NOTE A: fin is a sine wave.

#### Figure 6-6. Frequency Response (Switch On)

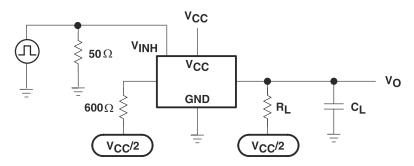


Figure 6-7. Crosstalk (Control Input, Switch Output)

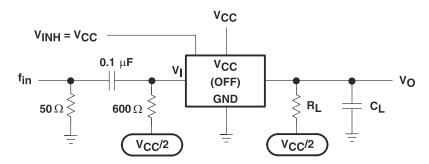


Figure 6-8. Feedthrough Attenuation (Switch Off)

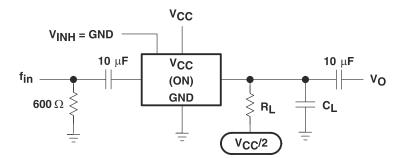


Figure 6-9. Sine-Wave Distortion

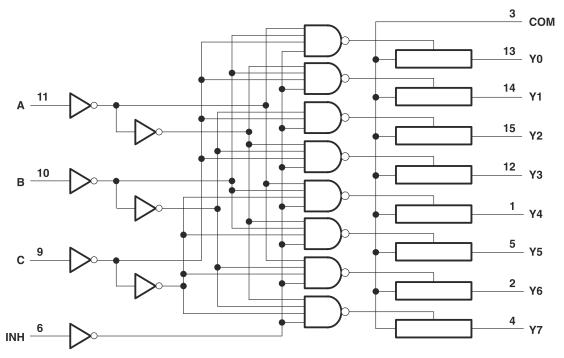


## **7 Detailed Description**

### 7.1 Overview

This device is an 8-channel analog multiplexer. A multiplexer is used when several signals must share the same device or resource. This device allows the selection of one of these signals at a time, for analysis or propagation.

### 7.2 Functional Block Diagram



### 7.3 Feature Description

This device contains one 8-channel multiplexer for use in a variety of applications, and can also be configured as demultiplexer by using the COM pin as an input and the Yx pins as outputs. This device is qualified for automotive applications and has an extended temperature range of -40°C to 125°C (maximum depends on package type).

#### 7.4 Device Functional Modes

| Table 7-1. Function Table |     |    |   |         |  |  |  |  |  |
|---------------------------|-----|----|---|---------|--|--|--|--|--|
|                           | INP | ON |   |         |  |  |  |  |  |
| INH                       | С   | В  | Α | CHANNEL |  |  |  |  |  |
| L                         | L   | L  | L | Y0      |  |  |  |  |  |
| L                         | L   | L  | Н | Y1      |  |  |  |  |  |
| L                         | L   | Н  | L | Y2      |  |  |  |  |  |
| L                         | L   | Н  | Н | Y3      |  |  |  |  |  |
| L                         | Н   | L  | L | Y4      |  |  |  |  |  |
| L                         | Н   | L  | Н | Y5      |  |  |  |  |  |
| L                         | Н   | Н  | L | Y6      |  |  |  |  |  |
| L                         | Н   | Н  | н | Y7      |  |  |  |  |  |
| Н                         | Х   | Х  | Х | None    |  |  |  |  |  |

## lo 7.1 Eurotion Table



## 8 Application and Implementation

#### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 8.1 Application Information

A multiplexer is used in applications where multiple signals share a resource. In the example below, several different sensors are connected to the analog-to-digital converter (ADC) of a microcontroller unit (MCU).

### **8.2 Typical Application**

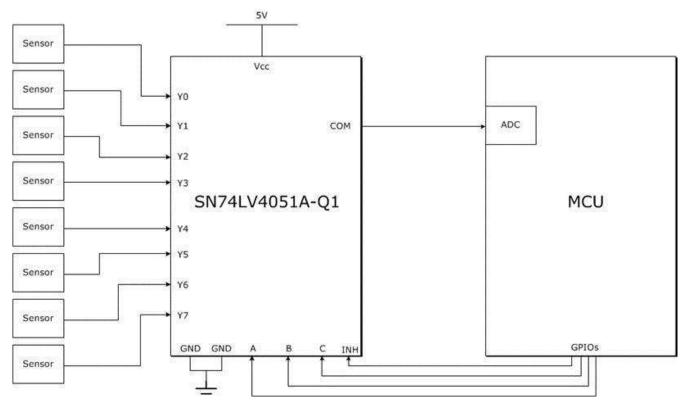


Figure 8-1. Example of Multiplexer Use With Analog Sensors and the ADC of an MCU

#### 8.2.1 Design Requirements

Designing with the SN74LV4051A-Q1 device requires a stable input voltage between 2 V (see *Recommended Operating Conditions* for details) and 5.5V. Another important design consideration are the characteristics of the signal being multiplexed—ensure no important information is lost due to timing or incompatibility with this device.

#### 8.2.2 Detailed Design Procedure

Processing eight different analog signals would normally require eight separate ADCs, but Figure 8-1 shows how to achieve this using only one ADC and four GPIOs (general-purpose input/outputs).



### 8.3 Power Supply Recommendations

Most systems have a common 3.3V or 5V rail that can supply the Vcc pin of this device. If this is not available, a switched-mode power supply (SMPS) or a low dropout regulator (LDO) can supply this device from a higher voltage rail.

#### 8.4 Layout

#### 8.4.1 Layout Guidelines

TI recommends keeping the signal lines as short and as straight as possible. Incorporation of microstrip or stripline techniques is also recommended when signal lines are more than 1 inch long. These traces must be designed with a characteristic impedance of either  $50\Omega$  or  $75\Omega$ , as required by the application. Do not place this device too close to high-voltage switching components, as they may cause interference.

#### 8.4.2 Layout Example

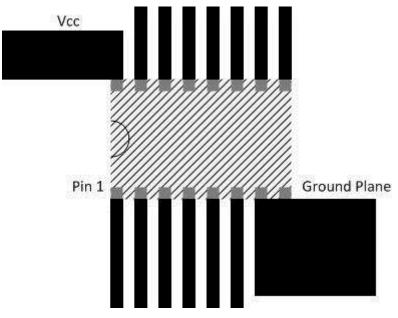


Figure 8-2. Layout Schematic



## 9 Device and Documentation Support

### 9.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### 9.2 Support Resources

TI E2E<sup>™</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

#### 9.3 Trademarks

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#### 9.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 9.5 Glossary

TI Glossary This glossary lists and explains terms, acronyms, and definitions.

## **10 Revision History**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| C | hanges from Revision F (June 2024) to Revision G (September 2024) | Page |
|---|-------------------------------------------------------------------|------|
| • | Added DYY package and size                                        | 1    |
| • | Added DYY package                                                 | 3    |
| • | Added DYY package                                                 | 5    |

| С | hanges from Revision E (January 2015) to Revision F (June 2024)                                | Page           |
|---|------------------------------------------------------------------------------------------------|----------------|
| • | Updated the numbering format for tables, figures, and cross-references throughout the document | 1              |
| • | Updated the Package Information table to include package lead size                             | 1              |
| • | Added new VIH and VIL Specifications at 1.65V Vcc                                              | <mark>6</mark> |
| • | Added new VIH and VIL Specifications at 1.65V Vcc                                              | <mark>6</mark> |
| • | Added Ron, Ron Peak, and Delta Ron Specifications at 1.65V Vcc                                 | 6              |

| С | hanges from Revision D (June 2011) to Revision E (January 2015)                                | Page |
|---|------------------------------------------------------------------------------------------------|------|
| • | Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and |      |
|   | Implementation section, Power Supply Recommendations section, Layout section, Device and       |      |
|   | Documentation Support section, and Mechanical, Packaging, and Orderable Information section    | 1    |



## 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



## PACKAGING INFORMATION

| Orderable Device   | Status   | Package Type | Package | Pins | Package | Eco Plan     | Lead finish/  | MSL Peak Temp      | Op Temp (°C) | Device Marking | Samples |
|--------------------|----------|--------------|---------|------|---------|--------------|---------------|--------------------|--------------|----------------|---------|
|                    | (1)      |              | Drawing |      | Qty     | (2)          | Ball material | (3)                |              | (4/5)          |         |
|                    |          |              |         |      |         |              | (6)           |                    |              |                |         |
| CLV4051ATDWRG4Q1   | NRND     | SOIC         | DW      | 16   | 2000    | RoHS & Green | NIPDAU        | Level-1-260C-UNLIM | -40 to 105   | L4051AQ        |         |
| CLV4051ATPWRG4Q1   | OBSOLETE | TSSOP        | PW      | 16   |         | TBD          | Call TI       | Call TI            | -40 to 105   | L4051AQ        |         |
| SN74LV4051AQDYYRQ1 | ACTIVE   | SOT-23-THIN  | DYY     | 16   | 3000    | RoHS & Green | NIPDAU        | Level-1-260C-UNLIM | -40 to 125   | LV4051Q        | Samples |
| SN74LV4051AQPWRQ1  | ACTIVE   | TSSOP        | PW      | 16   | 2000    | RoHS & Green | NIPDAU        | Level-1-260C-UNLIM | -40 to 125   | 4051AQ1        | Samples |
| SN74LV4051ATDRQ1   | NRND     | SOIC         | D       | 16   | 2500    | RoHS & Green | NIPDAU        | Level-1-260C-UNLIM | -40 to 105   | L4051AQ        |         |
| SN74LV4051ATDWRQ1  | NRND     | SOIC         | DW      | 16   | 2000    | RoHS & Green | NIPDAU        | Level-1-260C-UNLIM | -40 to 105   | L4051AQ        |         |
| SN74LV4051ATPWRQ1  | ACTIVE   | TSSOP        | PW      | 16   | 2000    | RoHS & Green | NIPDAU        | Level-1-260C-UNLIM | -40 to 105   | L4051AQ        | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW**: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



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## PACKAGE OPTION ADDENDUM

13-Sep-2024

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#### OTHER QUALIFIED VERSIONS OF SN74LV4051A-Q1 :

- Catalog : SN74LV4051A
- Enhanced Product : SN74LV4051A-EP

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Enhanced Product Supports Defense, Aerospace and Medical Applications

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